

BEST AVAILABLE COPY

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application



3C3
3C895

APPL NUM 10007754	FILING DATE 11/15/2001	CLASS 257 280	SUBCLASS 197	GAU 2876 2812	EXAMINER F. MANDALA
**APPLICANTS: Hill Darrell; Sadaka Mariam; Abrokwhah Jonathan;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A DIV OF 09/641,002 08/17/2000 <i>LATTIN 438</i> <i>2812</i>					
**FOREIGN APPLICATIONS VERIFIED:					
PG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO	
Verified and Acknowledged Examiner's initials				SC10776P D01	
TITLE : Method of manufacturing a semiconductor component and semiconductor component thereof					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner		DRAWING	
		Sheets Drwg.	Figs. Drwg.
Primary Examiner		Print Fig.	
PREPARED FOR ISSUE		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	

FILED WITH:

☐ DISK (CRF)

☐ CD-ROM

(Attached in pocket on right inside flap)